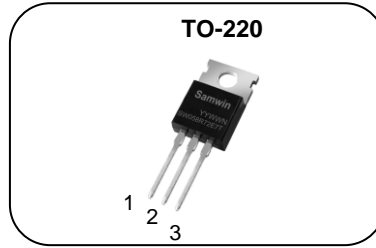


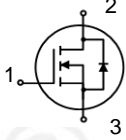
## N-channel Enhanced mode TO-220 MOSFET

### Features

- High ruggedness
- Low  $R_{DS(ON)}$  (Typ 6.3m $\Omega$ )@ $V_{GS}=10V$
- Low Gate Charge (Typ 107nC)
- Improved dv/dt Capability
- 100% Avalanche Tested
- Application: Synchronous Rectification, Li Battery Protect Board, Inverter



1. Gate 2.Drain 3.Source

$BV_{DSS}$ : 72V
$I_D$ : 100A
$R_{DS(ON)}$ : 6.3m $\Omega$


### General Description

This power MOSFET is produced with advanced technology of SAMWIN. This technology enable the power MOSFET to have better characteristics, including fast switching time, low on resistance, low gate charge and especially excellent avalanche characteristics.

### Order Codes

Item	Sales Type	Marking	Package	Packaging
1	SW P 058R72E7T	SW058R72E7T	TO-220	TUBE

### Absolute maximum ratings

Symbol	Parameter	Value	Unit
$V_{DSS}$	Drain to source voltage	72	V
$I_D$	Continuous drain current (@ $T_C=25^{\circ}C$ )	100*	A
	Continuous drain current (@ $T_C=100^{\circ}C$ )	80*	A
$I_{DM}$	Drain current pulsed (note 1)	400	A
$V_{GS}$	Gate to source voltage	$\pm 20$	V
$E_{AS}$	Single pulsed avalanche energy (note 2)	240	mJ
$E_{AR}$	Repetitive avalanche energy (note 1)	24	mJ
dv/dt	Peak diode recovery dv/dt (note 3)	5	V/ns
$P_D$	Total power dissipation (@ $T_C=25^{\circ}C$ )	223.2	W
	Derating factor above 25 $^{\circ}C$	1.8	W/ $^{\circ}C$
$T_{STG}, T_J$	Operating junction temperature & storage temperature	-55 ~ + 150	$^{\circ}C$
$T_L$	Maximum lead temperature for soldering purpose, 1/8 from case for 5 seconds.	300	$^{\circ}C$

\*. Drain current is limited by junction temperature.

### Thermal characteristics

Symbol	Parameter	Value	Unit
$R_{thjc}$	Thermal resistance, Junction to case	0.56	$^{\circ}C/W$
$R_{thja}$	Thermal resistance, Junction to ambient	47	$^{\circ}C/W$

## Electrical characteristic ( $T_J = 25^\circ\text{C}$ unless otherwise specified )

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
<b>Off characteristics</b>						
$BV_{DSS}$	Drain to source breakdown voltage	$V_{GS}=0V, I_D=250\mu A$	72			V
$\Delta BV_{DSS} / \Delta T_J$	Breakdown voltage temperature coefficient	$I_D=250\mu A$ , referenced to $25^\circ\text{C}$		0.07		V/ $^\circ\text{C}$
$I_{DSS}$	Drain to source leakage current	$V_{DS}=72V, V_{GS}=0V$			1	$\mu A$
		$V_{DS}=58V, T_J=125^\circ\text{C}$			50	$\mu A$
$I_{GSS}$	Gate to source leakage current, forward	$V_{GS}=20V, V_{DS}=0V$			100	nA
	Gate to source leakage current, reverse	$V_{GS}=-20V, V_{DS}=0V$			-100	nA
<b>On characteristics</b>						
$V_{GS(TH)}$	Gate threshold voltage	$V_{DS}=V_{GS}, I_D=250\mu A$	2		4	V
$R_{DS(ON)}$	Drain to source on state resistance	$V_{GS}=10V, I_D=40A, T_J=25^\circ\text{C}$		6.3	7.3	m $\Omega$
		$V_{GS}=10V, I_D=40A, T_J=125^\circ\text{C}$		11		m $\Omega$
$G_{fs}$	Forward transconductance	$V_{DS}=5V, I_D=40A$		57		S
<b>Dynamic characteristics</b>						
$C_{iss}$	Input capacitance	$V_{GS}=0V, V_{DS}=36V, f=1\text{MHz}$		5302		pF
$C_{oss}$	Output capacitance			314		
$C_{rss}$	Reverse transfer capacitance			293		
$t_{d(on)}$	Turn on delay time	$V_{DS}=36V, I_D=30A, R_G=4.7\Omega, V_{GS}=10V$ (note 4,5)		31		ns
$t_r$	Rising time			72		
$t_{d(off)}$	Turn off delay time			99		
$t_f$	Fall time			40		
$Q_g$	Total gate charge	$V_{DS}=58V, V_{GS}=10V, I_D=30A, I_G=4\text{mA}$ (note 4,5)		107		nC
$Q_{gs}$	Gate-source charge			26		
$Q_{gd}$	Gate-drain charge			28		
$R_g$	Gate resistance	$V_{DS}=0V$ , Scan F mode		3.2		$\Omega$

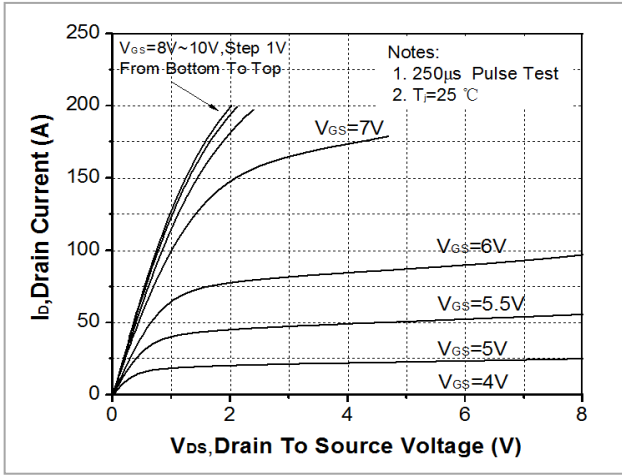
## Source to drain diode ratings characteristics

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
$I_S$	Continuous source current	Integral reverse p-n Junction diode in the MOSFET			100	A
$I_{SM}$	Pulsed source current				400	A
$V_{SD}$	Diode forward voltage drop.	$I_S=50A, V_{GS}=0V$			1.4	V
$t_{rr}$	Reverse recovery time	$I_S=30A, V_{GS}=0V,$		36		ns
$Q_{rr}$	Reverse recovery charge	$di/dt=100A/\mu s$		39		nC

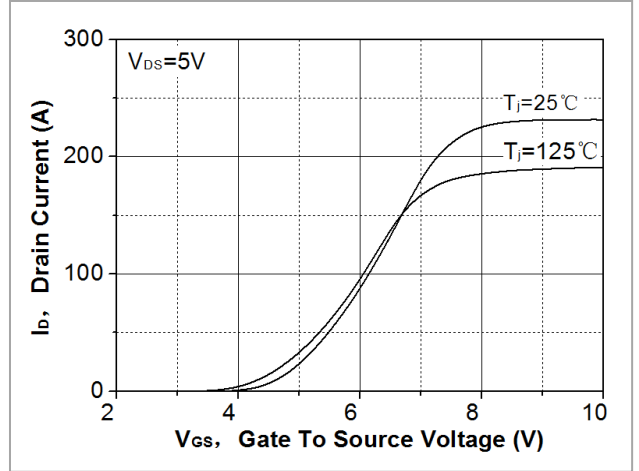
### ※. Notes

1. Repeattive rating : pulse width limited by junction temperature.
2.  $L=0.5\text{mH}, I_{AS}=31A, V_{DD}=35V, R_G=25\Omega$ , Starting  $T_J=25^\circ\text{C}$
3.  $I_{SD} \leq 30A, di/dt = 100A/\mu s, V_{DD} \leq BV_{DSS}$ , Starting  $T_J=25^\circ\text{C}$
4. Pulse Test : Pulse Width  $\leq 300\mu s$ , duty cycle  $\leq 2\%$ .
5. Essentially independent of operating temperature.

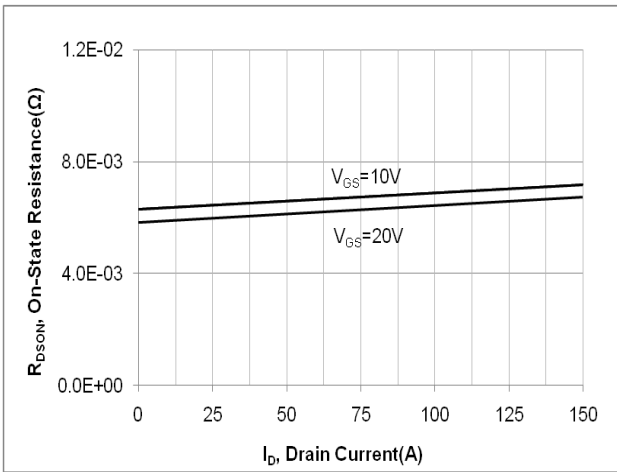
**Fig. 1. On-state characteristics**



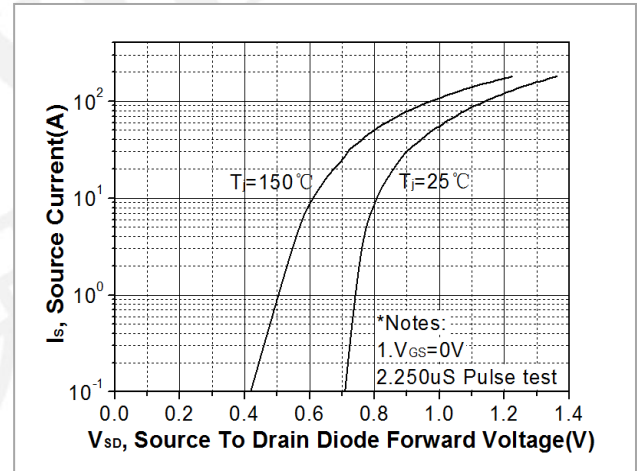
**Fig. 2. Transfer Characteristics**



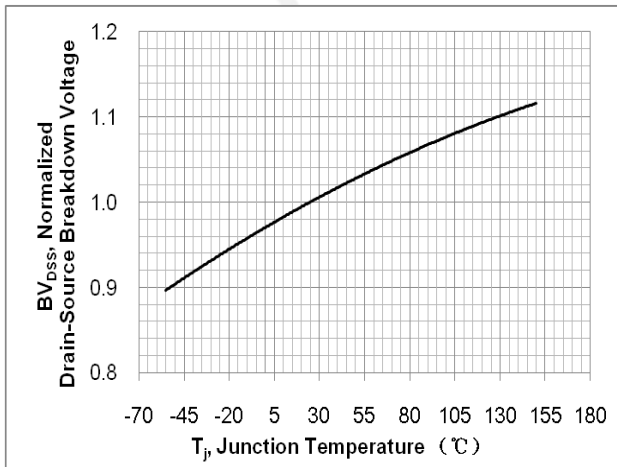
**Fig. 3. On-resistance variation vs. drain current and gate voltage**



**Fig. 4. On-state current vs. diode forward voltage**



**Fig 5. Breakdown voltage variation vs. junction temperature**



**Fig. 6. On-resistance variation vs. junction temperature**

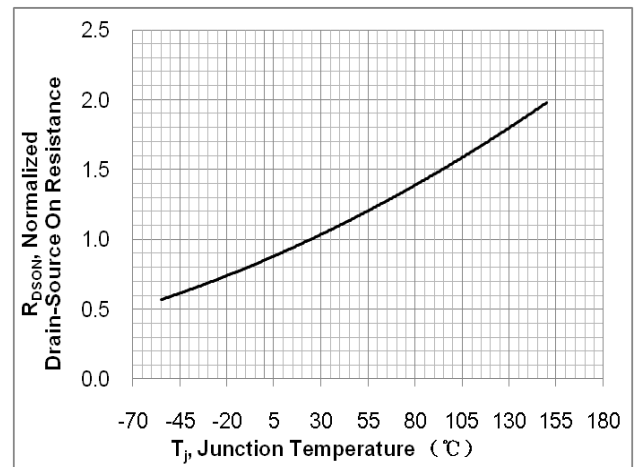


Fig. 7. Gate charge characteristics

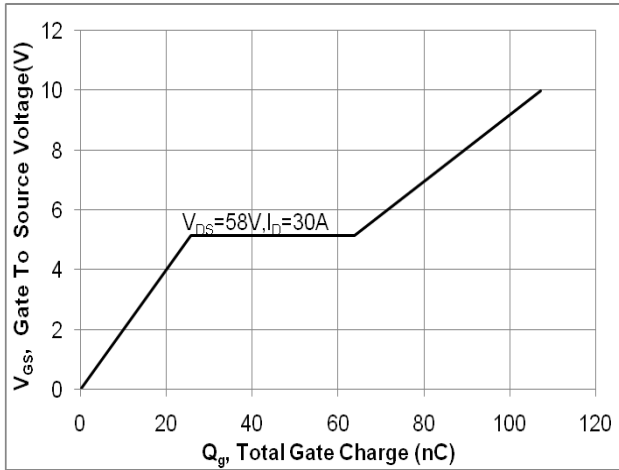


Fig. 8. Capacitance Characteristics

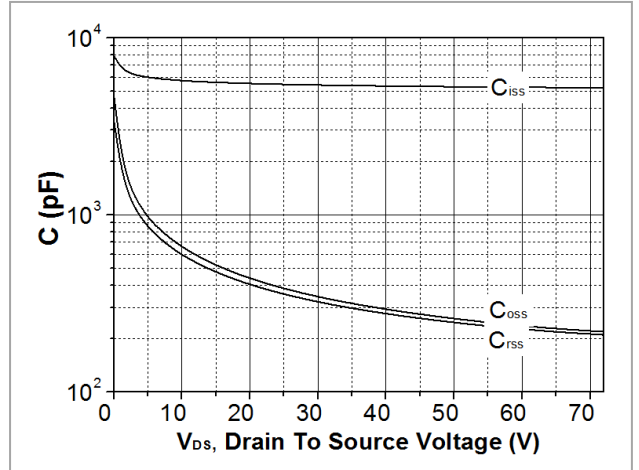


Fig. 9. Maximum safe operating area

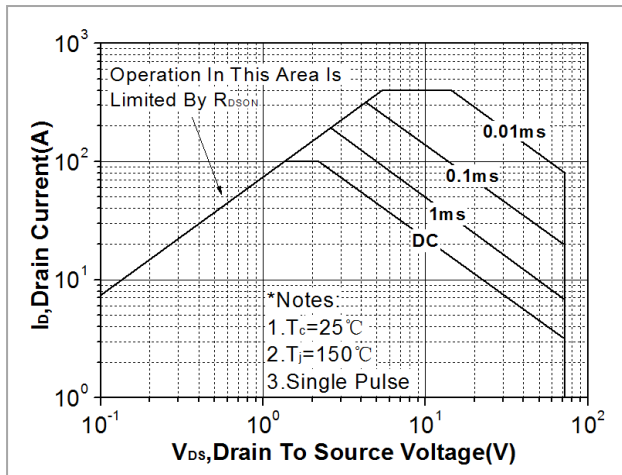


Fig. 10. Maximum drain current vs. case temperature

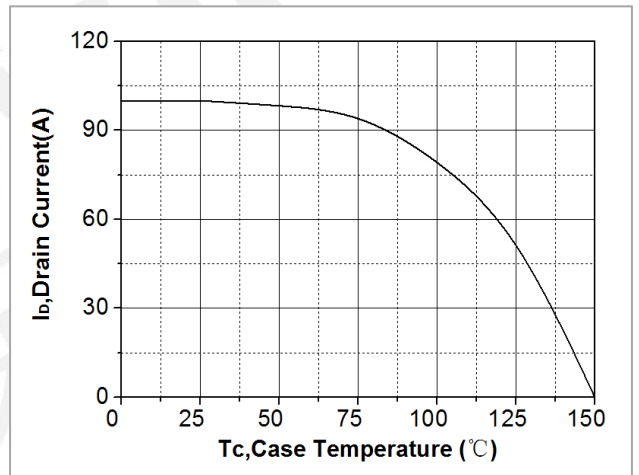
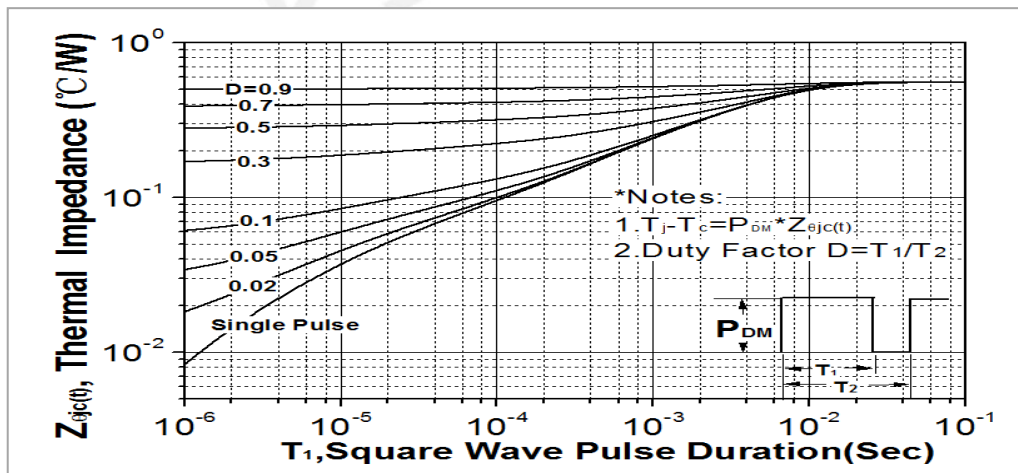


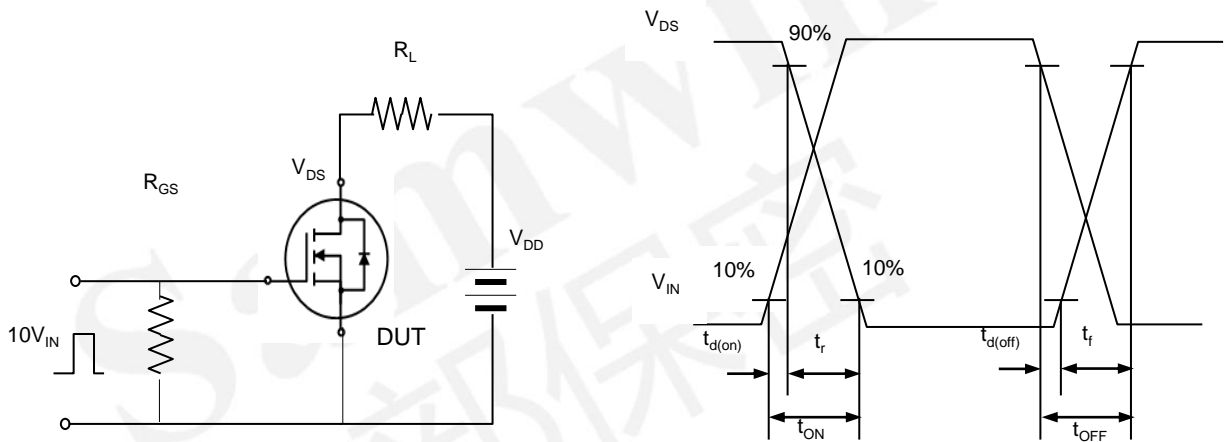
Fig. 11. Transient thermal response curve



**Fig. 12. Gate charge test circuit & waveform**



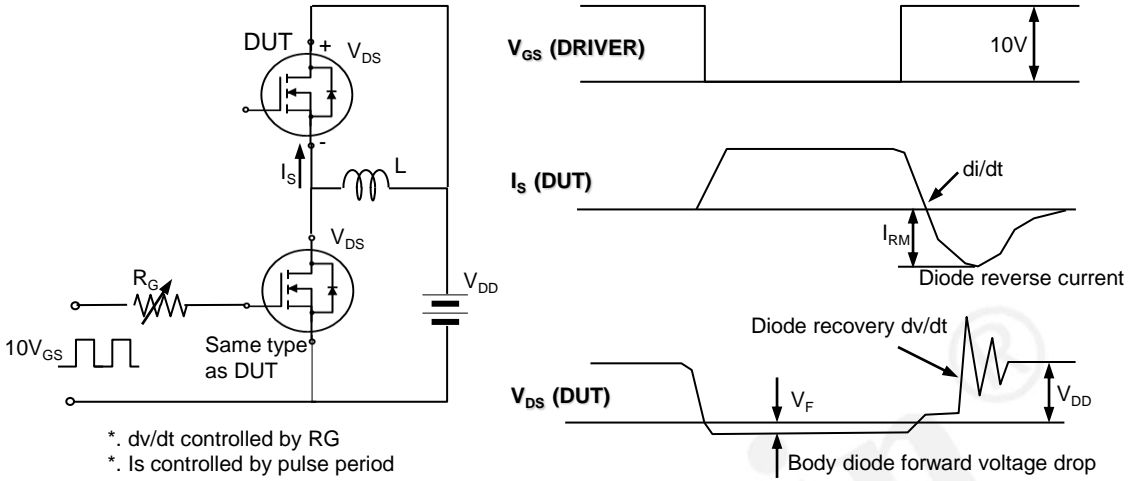
**Fig. 13. Switching time test circuit & waveform**



**Fig. 14. Unclamped Inductive switching test circuit & waveform**




Fig. 15. Peak diode recovery dv/dt test circuit & waveform



### DISCLAIMER

\* All the data & curve in this document was tested in SEMIPOWER TESTING & APPLICATION CENTER.

\* This product has passed the PCT,TC,HTRB,HTGB,HAST,PC and Solderdunk reliability testing.

\* Qualification standards can also be found on the Web site (<http://www.semipower.com.cn>) 

\* Suggestions for improvement are appreciated, Please send your suggestions to [samwin@samwinsemi.com](mailto:samwin@samwinsemi.com)

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